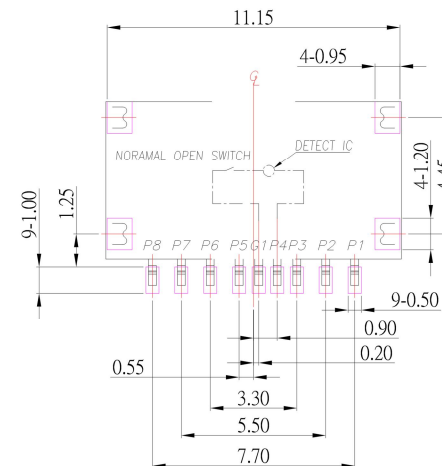
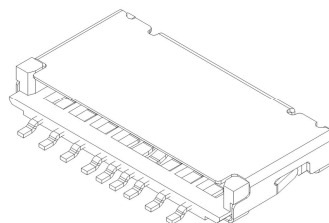
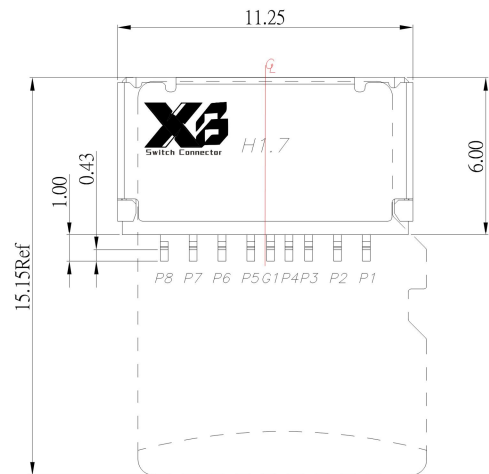
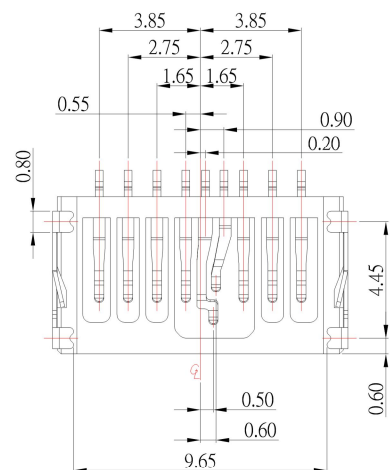
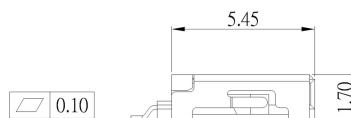
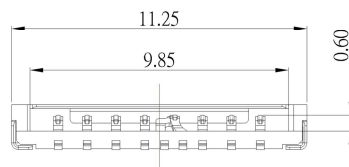




P.C.B LAYOUT MOUNTING PATTERN



P8	DAT1
P7	DAT0
P6	VSS
P5	CLK
G1	SWITCH
P4	VDD
P3	CMD
P2	CD/DAT3
P1	DAT2
PIN NUMBER	PIN NUMBER

Material:

- 1.Housing: LCP,Black
- 2.Contact: Phosphor Bronze
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

TOLERANCE UNLESS OTHERWISE STATED:
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 03/19/20
DATE: 03/19/20
DATE: 03/19/20

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	MICRO SD CARD / P4,P5 帶偵測
SCALE	1 : 1	DWG NO.	SD-TF21-41709-S267
SHEET NO.	1 of 1	PART NO.	SD-TF21-41709-S267

SIZE
A4
VER
R1